## 506209929 08/18/2020

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
LIN-YU HUANG	08/05/2020
LI-ZHEN YU	08/05/2020
CHIA-HAO CHANG	08/05/2020
CHENG-CHI CHUANG	08/05/2020
KUAN-LUN CHENG	08/05/2020
CHIH-HAO WANG	08/06/2020

#### **RECEIVING PARTY DATA**

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Street Address:	NO.8, LI-HSIN RD.6
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	16943996	

### **CORRESPONDENCE DATA**

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SIGNATURE:	/R. Burns Israelsen/
DATE SIGNED:	08/18/2020

PATENT 506209929 REEL: 053531 FRAME: 0001

# **Total Attachments: 2**

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PATENT REEL: 053531 FRAME: 0002 NP2001432US00

### ASSIGNMENT



This assignment agreement is applicable to an invention entitled (Invention Title)			
SEMICONDUCTOR DEVICE STRUCTURE AND METHODS OF FORMING THE			
SAME			
The PATENT RIGHTS referred to in this agreement are:			
(check one) a patent application for this invention, executed by the ASSIGNOR(S)			
concurrently with this assignment.			
☑U.S. patent application Serial No. 16/943,996 , filed July 30, 2020			
a U.S. patent application based on PCT International Application			
Nofiled on (date)(U.S. patent application			
Serial No, if known).			
U.S. patent No, issued			
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of			
the patents and patent applications identified above.			
The PATENT RIGHTS assigned under this agreement are:			
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures			
appear on page 2 of this Assignment and any Supplemental Sheet(s).			
The ASSIGNEE referred to in this agreement is:			
(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.			
(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,			
TAIWAN 300, R.O.C.			
The ASSIGNEE is:			
(check one) An individual.			
A Partnership.			
☐ A Corporation of			
(other)			
The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and			
valuable consideration, receipt of which is acknowledged, hereby assign(s) the following			
rights to the ASSIGNEE, its successors and assigns:			
the full and exclusive right to the invention;			
the entire right, title and interest in and to the PATENT RIGHTS;			
the right to sue and recover for any past infringement; and			
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable			

provisions, based on any earlier patent applications for this invention.

PATENT REEL: 053531 FRAME: 0003

**RECORDED: 08/18/2020** 

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. INVENTION TITLE: SEMICONDUCTOR DEVICE STRUCTURE AND METHODS OF FORMING THE SAME

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Lin-Yu HUANG	Lm-Yu Huana	<del>08</del> /05/2020
Name of sole or first inventor	Signature	Date
Li-Zhen YU	Lithen U.	08/02/2020
Name of second inventor, if any	Signature	Date
Chia-Hao CHANG	<u> Ma Hao Chang</u> Signature	08/65/2020
Name of third inventor, if any		Date
Cheng-Chi CHUANG	Oherg Chil Ohnang	08/05/2020
Name of fourth inventor, if any	Signature	Date
Kuan-Lun CHENG	Huan-hun Chang	2020/8/5
Name of fifth inventor, if any	Signature /	Date
Chih-Hao WANG	Chih-Hao Wung	8/6/2020
Name of sixth inventor, if any	Signature	Date

PATENT REEL: 053531 FRAME: 0004